



Typically used in customer premise equipment, main distribution frame,
Subscriber line interface card and exchange, etc.
可用于用户设备、主配线架、SLIC及交换机等设备中

Electrical Characteristics at 25°C

25°C 电气性能

Model	V_{max}	I_{max}	I_{hold}	I_{trip}	$R_{initial}$	R_{1max}	Max. Time To Trip	
	Volts	Amps	Amps	Amps	Ohms	Ohms	Amps	Seconds
250-050T	250	3.0	0.05	0.12	30.0-60.0	90	1.0	3.0
250-080T	250	3.0	0.08	0.16	12.0-22.0	33.0	1.0	4.0
250-110T	250	3.0	0.11*	0.22*	6.0-12.0	16.0	0.35	18.0
250-120T	250	3.0	0.12	0.22	6.0-12.0	16.0	1.0	2.5

*at 40°C

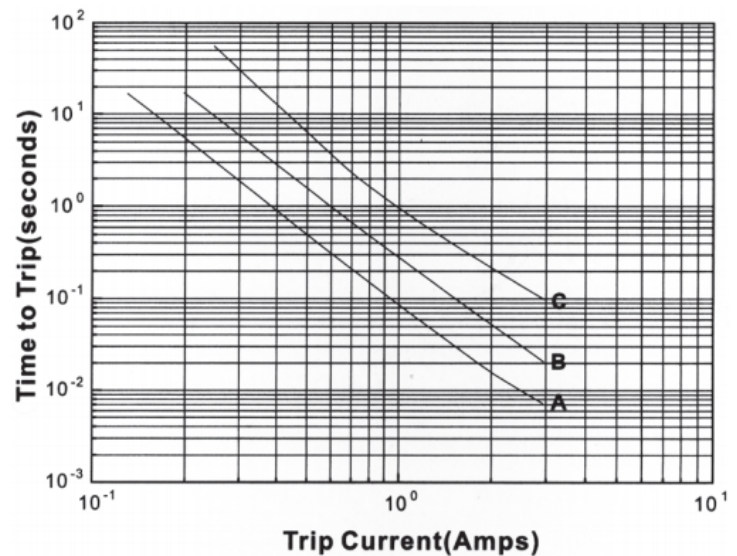
Typical Time to Trip at 25°C

25°C典型的动作时间

A: 250-050T

B: 250-080T

C: 250-110T/250-120T



Environmental Characteristics

环境特性

Operating/Storage Temperature -40°C to +85°C

环境/储存

Storage Note: $T_{max}=+40^{\circ}\text{C}$, $RH_{max}=70\%$. Units might not meet the nominal value if storage conditions are over limit.

注：存储条件最高温度+40°C，最大RH70%；如果超过存储条件，器件可能无法满足给定值

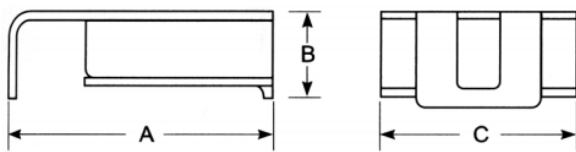
Maximum Device Surface Temperature 125°C

最大表面温度

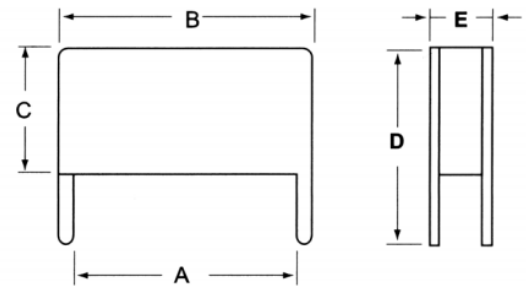
Test/测试项目	Conditions/测试条件
Passive aging 高温老化	85°C, 1000 hours
Humidity aging 恒定湿热老化	85°C, 85%RH, 1000 hours
Thermal shock 热冲击	85°C, -40°C (10 times)
Solvent proof 耐溶剂特性	MIL-STD-202, Method 215F

Part Numbering System:

型号说明



Style 1



Style 2

Product Dimensions(mm/inch)

尺寸 (毫米/英寸)

Model	A _{max}	B _{max}	C _{max}	D _{nom.}	Style	Lead Dia.	Lead Mat.
250-050T	9.5/0.374	4.0/0.157	7.5/0.295		1	0.3/0.012	Sn/Cu
250-080T	9.5/0.374	4.0/0.157	7.5/0.295		1	0.3/0.012	Sn/Cu
250-110T	5.8/0.228	7.0/0.276	3.0/0.118	5.0/0.179	2	0.3/0.012	Sn/Cu
250-120T	9.5/0.374	4.0/0.157	7.5/0.295		1	0.3/0.012	Sn/Cu

Thermal Derating-Ihold(Amps)

维持电流随温度衰减特性 (安培)

Model	Ambient Operating Temperature								
	-40℃	-20℃	0℃	25℃	40℃	50℃	60℃	70℃	85℃
250-050T	0.087	0.075	0.064	0.050	0.042	0.034	0.029	0.024	0.016
250-080T	0.122	0.108	0.098	0.080	0.072	0.066	0.055	0.046	0.034
250-110T	0.186	0.164	0.150	0.122	0.110	0.100	0.084	0.070	0.052
250-120T	0.186	0.165	0.143	0.120	0.099	0.088	0.077	0.066	0.050